- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

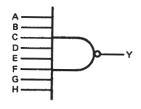
These devices contain a single 8-input NAND gate.

The SN5430, SN54LS30, and SN54S30 are characterized for operation over the full military range of -55 °C to 125 °C. The SN7430, SN74LS30, and SN74S30 are characterized for operation from 0 °C to 70 °C.

#### FUNCTION TABLE

INPUTS A THRU H	OUTPUT Y
All inputs H	L
One or more inputs L	н

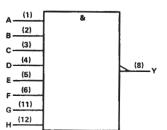
#### logic diagram



#### positive logic

$$Y = \overline{A \cdot B \cdot C \cdot D \cdot E \cdot F \cdot G \cdot H} \quad \text{or}$$
$$Y = \overline{A} + \overline{B} + \overline{C} + \overline{D} + \overline{F} + \overline{F} + \overline{G} + \overline{H}$$

logic symbol<sup>†</sup>



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



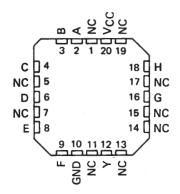
SN5430 J PACKAGE
SN54LS30, SN54S30 J OR W PACKAGE
SN7430 N PACKAGE
SN74LS30, SN74S30 D OR N PACKAGE
(TOP VIEW)

A [] B []2 C []3 D []4 E []5 F []6	14 VCC 13 NC 12 H 11 G 10 NC 9 NC
F 🗍 6	9Д №С
	8 T Y

	W PACKAGE OP VIEW)
NC []	
A 2	13 NC
в 🖾 з	12 Y
Vcc □₄	
C 🗆 5	10 H

D 🗍 6	9 🗍 G
E [] 7	8 F

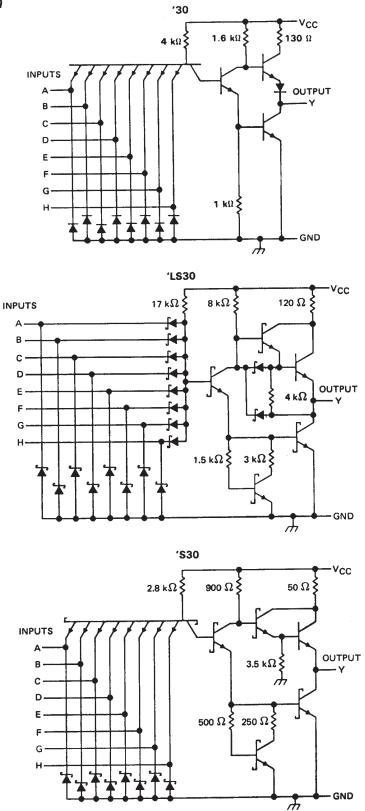
### SN54LS30, SN54S30 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

### SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT POSITIVE-NAND GATES SDLS099 - DECEMBER 1983 - REVISED MARCH 1988

### schematics (each gate)



Resistor values shown are nominal.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT PÓSITIVE-NAND GATES

SDLS099 - DECEMBER 1983 - REVISED MARCH 1988

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	. 7 V
nput voltage	5.5 V
Dperating free-air temperature range: SN5430	25°C
SN7430 0°C to	70°C
Storage temperature range $\dots \dots \dots$	50°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN5430	)		UNIT				
		MIN	NOM	MAX	MIN	NOM	мах	UNIT		
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V		
ViH	High-level input voltage	2			2			v		
VIL	Low-level input voltage			0.8			0.8	v		
юн	High-level output current			- 0.4			- 0.4	mA		
IOL	Low-level output current			16			16	mA		
т <sub>А</sub>	Operating free-air temperature	- 55		125	0		70	°c		

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN5430			SN7430			
PARAMETER		TEST CONDITIONS T		TYP‡	мах	MIN	TYP‡	MAX	UNIT	
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = – 12 mA			- 1.5			- 1.5	V	
VOH	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V, 1 <sub>OH</sub> = - 0.4 mA	2.4	3.4		2.4	3.4		V	
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V	
4	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V			1			1	mA	
ін	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.4 V			40			40	μA	
կլ	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			- 1.6			- 1.6	mA	
IOS§	V <sub>CC</sub> = MAX		- 20		- 55	- 18		- 55	mA	
ICCH	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0		. 1	2		1	2	mA	
1CCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V		3	6		3	6	mA	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAN	METER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	ТҮР	MAX	UNIT	
tPLI	н						13	22	ns
tрн	L	Апу		R <sub>L</sub> = 400 Ω,	C <sub>L</sub> = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT POSITIVE-NAND GATES

SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1) 7 V	/
Input voltage	/
Operating free-air temperature range: SN54LS30	2
SN74LS30	
Storage temperature range	2

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN54LS	30		UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	
vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
юн	High-level output current			- 0.4			- 0.4	mA
IOL	Low-level output current			4			8	mA
Τ <sub>A</sub>	Operating free-air temperature	- 55		125	0		70	°c

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS T								
PARAMETER				MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = — 18 mA				- 1.5			- 1.5	V
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	VIL = MAX,	l <sub>OH</sub> = - 0.4 mA	2.5	3.4		2.7	3.4		v
	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	l <sub>OL</sub> ≡ 4 mA		0.25	0.4			0.4	- ~
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	i <sub>OL</sub> = 8 mA					0.25	0.5	
ly ly	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
ίн	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V	· · · · · · · · · · · · · · · · · · ·			20			20	μA
IIL.	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 0.4			- 0.4	mA
IOS§	V <sub>CC</sub> = MAX			- 20		- 100	- 20		- 100	mA
Іссн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0			0.35	0.5		0.35	0.5	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			0.6	.1.1		0.6	1.1	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>o</sup>C

§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	мах	UNIT
<sup>t</sup> PLH	<b>A b v</b>	v	$R_1 = 2 k \Omega$ , $C_1 = 15 pF$		8	15	ns
<sup>t</sup> PHL	Any	т	R <sub>L</sub> = 2 kΩ, C <sub>L</sub> = 15 pF		13	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT PÓSITIVE-NAND GATES

SDLS099 - DECEMBER 1983 - REVISED MARCH 1988

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage	
Operating free-air temperature range: SN54S30	-55°C to 125°C
SN74S30	
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN54S3	0		SN74S3	30	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIН	High-level input voltage	2			2			v
VIL	Low-level input voltage			0.8			0.8	v
юн	High-level output current			- 1			- 1	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		7507 004017	ione t		SN54S3	0		30	UNIT	
PARAMETER		TEST CONDIT	IONSI	MIN	TYP‡	MAX	MIN	TYP‡	МАХ	
VIK	V <sub>CC</sub> = MIN,	1 <sub>1</sub> = -18 mA				-1.2			-1.2	v
∨он	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V,	1 <sub>OH</sub> = - 1 mA	2.5	3.4		2.7	3.4		v
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	1 <sub>OL</sub> = 20 mA			0.5			0.5	v
· 1	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mA
Чн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				50			50	μA
ιL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.5 V				-2			-2	mA
I <sub>OS</sub> §	V <sub>CC</sub> = MAX			-40		-100	-40		-100	mA
ICCH	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0			3	5		3	5	mA
1CCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			5.5	10		5.5	10	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	түр	MAX	UNIT	
tPLH			R <sub>L</sub> = 280 Ω,	CL = 15 pF		4	6	ns
<sup>t</sup> PHL			112 - 200 417			4.5	7	ns
tPLH	Any					5.5		ns
<sup>t</sup> PHL			$R_{L} = 280 \Omega$ ,	С <sub>L</sub> = 50 рF		6.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9679201QCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Samples
5962-9679201QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
5962-9679201QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
JM38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
JM38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
M38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
M38510/30009B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009B2A	Samples
M38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
M38510/30009BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BCA	Samples
M38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples
M38510/30009BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30009BDA	Samples



Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5430J	Samples
SN5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5430J	Samples
SN54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS30J	Samples
SN54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS30J	Samples
SN54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S30J	Samples
SN54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S30J	Samples
SN74LS30D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS30	Samples
SN74LS30N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NE4	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NE4	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS30N	Samples
SN74LS30NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS30	Samples
SN74LS30NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS30	Samples
SNJ5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430J	Samples
SNJ5430J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430J	Samples
SNJ5430W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430W	Samples



16-Dec-2021

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ5430W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5430W	Samples
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 30FK	Samples
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 30FK	Samples
SNJ54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30J	Samples
SNJ54LS30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30J	Sample
SNJ54LS30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30W	Sample
SNJ54LS30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS30W	Sample
SNJ54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Sample
SNJ54S30J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QC A SNJ54S30J	Sample
SNJ54S30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Samples
SNJ54S30W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9679201QD A SNJ54S30W	Sample

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".



# PACKAGE OPTION ADDENDUM

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption. **Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS30, SN74LS30 :

Catalog : SN74LS30

• Military : SN54LS30

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

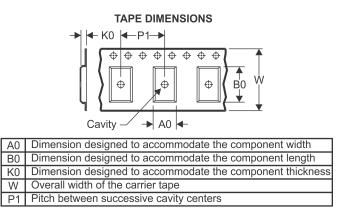
# PACKAGE MATERIALS INFORMATION

Texas Instruments

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### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	Il dimensions are nominal												
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS30DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74LS30NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



# PACKAGE MATERIALS INFORMATION

10-Mar-2022

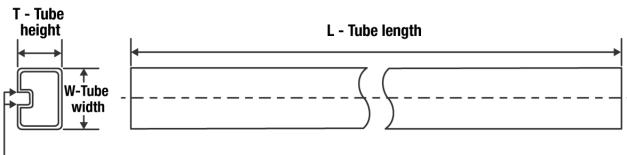


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS30DR	SOIC	D	14	2500	853.0	449.0	35.0
SN74LS30NSR	SO	NS	14	2000	853.0	449.0	35.0



### TUBE



-	B	-	Alignment	groove	width
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*All dimensions are nominal								
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
JM38510/30009B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30009BDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/30009B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30009BDA	W	CFP	14	1	506.98	26.16	6220	NA
SN74LS30D	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS30N	Ν	PDIP	14	25	506	13.97	11230	4.32
SN74LS30N	Ν	PDIP	14	25	506	13.97	11230	4.32
SN74LS30NE4	Ν	PDIP	14	25	506	13.97	11230	4.32
SN74LS30NE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS30FK	FK	LCCC	20	1	506.98	12.06	2030	NA

### Pack Materials-Page 3

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



### MECHANICAL DATA

### PLASTIC SMALL-OUTLINE PACKAGE

### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



# **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



# J0014A

# **EXAMPLE BOARD LAYOUT**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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